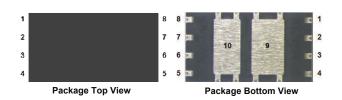
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40 V N- and P-Channel Common Drain MOSFET Pair and 200 V N-Channel MOSFET



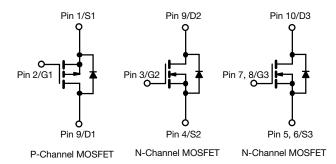
PRODUCT SUMMARY						
	N-CH 2	P-CH 1	N-CH 3			
V _{DS} (V)	40	-40	200			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0092	0.030	0.060			
$R_{DS(on)}\left(\Omega\right)$ at V_{GS} = 4.5 V	0.0135	0.048	-			
I _D (A)	30	-30	20			
Q _g typ. (nC)	25.5	30.2	14			
Configuration	N- and p-pair					
Package	Triple die					

FEATURES

- Optimized triple die package
- TrenchFET[®] power MOSFET
- 100 % R_g and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912







ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER		SYMBOL	N-CH 2	P-CH 1	N-CH 3	UNIT
Drain-source voltage		V _{DS}	40	-40	200	V
Gate-source voltage		V _{GS}	20	20	20	v
Continuous drain current ($T_J = 175 \ ^\circ C$)	T _C = 25 °C	Ι _D	30	-30	20	
	T _C = 125 °C		30	-30	11	
Pulsed drain current (t = 300 µs)		I _{DM}	120	-120	60	А
Continuous source drain current	T _C = 25 °C	I _S	30	-30	20	~
	T _C = 125 °C		30	-30	11.4	
Single pulse avalanche current	L = 0.1 mH	I _{AS}	26.5	-25	20	
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	35	31	20	mJ
Maximum power dissipation	T _C = 25 °C	5	48	48	60	w
	T _C = 125 °C	P _D	16	16	20	vv
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175			°C

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	N-CH 2	P-CH 1	N-CH 3	UNIT	
Junction-to-case (drain)	R _{thJC}	2.6	2.6	2.4	°C/W	

Notes

- a. Package limited, $T_C = 25 \ ^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

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SPECIFICATIONS ($T_J = 25$	°C, unless c	otherwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							-
		V_{GS} = 0 V, I _D = 250 μ A	N-Ch 2	40	-	-	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \ \mu A$	P-Ch 1	-40	-	-	
		$V_{GS}=0~V,~I_D=250~\mu A$	N-Ch 3	200	-	-	v
		$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	N-Ch 2	1.5	2.0	2.5	v
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	P-Ch 1	1.5	2.0	2.5	
		$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	N-Ch 3	2.5	3.0	3.5	
			N-Ch 2	-	-	± 100	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	P-Ch 1	-	-	± 100	nA
			N-Ch 3	-	-	± 100	
		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	N-Ch 2	-	-	1	
		V _{DS} = -40 V, V _{GS} = 0 V	P-Ch 1	-	-	-1	
		V _{DS} = 200 V, V _{GS} = 0 V	N-Ch 3	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V, T _J = 125 °C	N-Ch 2	-	-	50	mA
		V _{DS} = -40 V, V _{GS} = 0 V, T _J = 125 °C	P-Ch 1	-	-	-50	
		$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$	N-Ch 3	-	-	50	
		$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	N-Ch 2	25	-	-	
On-state drain current ^a	I _{D(on)}	$V_{DS} \le 5 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	P-Ch 1	-25	-	-	А
	·D(01)	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	N-Ch 3	20	-	-	
		$V_{GS} = 10 \text{ V}, \text{ I}_D = 9.8 \text{ A}$	N-Ch 2	-	0.0077	0.0092	
		$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -6 \text{ A}$	P-Ch 1	-	0.0220	0.0300	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	N-Ch 3		0.0500	0.0600	Ω
	US(on)	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 8.9 \text{ A}$	N-Ch 2	_	0.0940	0.0135	52
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = -4.7 \text{ A}$	P-Ch 1		0.0360	0.0480	
		$V_{\rm GS} = 4.5$ V, $I_{\rm D} = -4.7$ A V _{DS} = 15 V, $I_{\rm D} = 9.8$ A	N-Ch 2	_	65	-	
Forward transconductance a	G .	$V_{DS} = -15 \text{ V}, \text{ I}_D = 9.8 \text{ A}$ $V_{DS} = -15 \text{ V}, \text{ I}_D = 6 \text{ A}$	P-Ch 1	-	16	-	s
Forward transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 0 \text{ A}$ $V_{DS} = 15 \text{ V}, \text{ I}_{D} = 19 \text{ A}$	N-Ch 3	-	19	-	
Dynamic ^b		$v_{\rm DS} = 15 v, i_{\rm D} = 19 {\rm A}$	N-CH 3	-	19	-	
Dynamic		V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz	N-Ch 2	-	1474	- 1	
Input capacitance	C _{iss}	$V_{DS} = -20 V$, $V_{GS} = 0 V$, $f = 1 MHz$	P-Ch 1	-	1302	-	
input capacitance	UISS	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	N-Ch 3	-	1450	-	
		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	N-Ch 2	-	218	-	
	C	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	P-Ch 1	-	210	-	ъĘ
Output capacitance	C _{oss}		N-Ch 3	-	116	-	pF
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		-		-	
	0	$V_{DS} = 20 V, V_{GS} = 0 V, f = 1 MHz$	N-Ch 2	-	89	-	
Reverse transfer capacitance	C _{rss}	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	P-Ch 1	-	154	-	
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	N-Ch 3	-	9	-	
-		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	N-Ch 2	-	23	-	
Total gate charge	Qg	$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$	P-Ch 1	-	30.2	-	-
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	N-Ch 3	-	14	-	
Gate-source charge	_	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	N-Ch 2	-	4.4	-	nC
	Q _{gs}	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	P-Ch 1	-	4.1	-	
	ļ	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	N-Ch 3	-	4.4	-	
		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	N-Ch 2	-	4.3	-	
Gate-drain charge	Q _{gd}	$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$	P-Ch 1	-	7.4	-	
		V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 10 A	N-Ch 3	-	5	-	
			N-Ch 2	-	-	2.1	
Gate resistance	Rg	f = 1 MHz	P-Ch 1	-	-	9.5	Ω
			N-Ch 3	-	-	2.9	

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PARAMETER	SYMBOL	TEST CONDITIONS			TYP.	MAX.	UNIT
Dynamic ^b							•
		$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = \text{20 V}, \ R_{\text{L}} = \text{2} \ \Omega \\ I_{\text{D}} = \text{10 A}, \ V_{\text{GEN}} = \text{10 V}, \ R_{\text{g}} = \text{1} \ \Omega \end{array}$	N-Ch 2	-	8	-	
Turn-on delay time	t _{d(on)}	$\label{eq:V_DD} \begin{array}{l} V_{DD} = \texttt{-20} \; V, \; R_L = 2 \; \Omega \\ I_D = \texttt{-10} \; A, \; V_GEN = \texttt{-10} \; V, \; R_g = 1 \; \Omega \end{array}$	P-Ch 1	-	7	-	
		$\begin{array}{l} V_{DD} = 100 \text{ V}, \text{R}_{\text{L}} = 5.2 \ \Omega \\ \text{I}_{\text{D}} = 10 \text{ A}, \text{V}_{\text{GEN}} = 10 \text{ V}, \text{R}_{\text{g}} = 2.5 \ \Omega \end{array}$	N-Ch 3	-	10	-	
		$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = \text{20 V}, \ R_{\text{L}} = \text{2} \ \Omega \\ I_{\text{D}} = \text{10 A}, \ V_{\text{GEN}} = \text{10 V}, \ R_{\text{g}} = \text{1} \ \Omega \end{array}$	N-Ch 2	-	12	-	
Rise time	t _r	$\label{eq:VDD} \begin{array}{l} V_{DD}=\text{-}20 \ V, \ R_{L}=2 \ \Omega \\ I_{D}=\text{-}10 \ A, \ V_{GEN}=\text{-}10 \ V, \ R_{g}=1 \ \Omega \end{array}$	P-Ch 1	-	9	-	
		$\begin{array}{l} V_{DD} = 100 \text{ V}, \text{R}_{\text{L}} = 5.2 \ \Omega \\ \text{I}_{\text{D}} = 10 \text{ A}, \text{V}_{\text{GEN}} = 10 \text{ V}, \text{R}_{\text{g}} = 2.5 \ \Omega \end{array}$	N-Ch 3	-	3	-	ns
Turn-off delay time		$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = \text{20 V}, \ R_{\text{L}} = \text{2} \ \Omega \\ I_{\text{D}} = \text{10 A}, \ V_{\text{GEN}} = \text{10 V}, \ R_{\text{g}} = \text{1} \ \Omega \end{array}$	N-Ch 2	-	22	-	115
	t _{d(off)}	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = -20 \text{ V}, \ \textbf{R}_{\text{L}} = 2 \ \Omega \\ \textbf{I}_{\text{D}} = -10 \text{ A}, \ \textbf{V}_{\text{GEN}} = -10 \text{ V}, \ \textbf{R}_{\text{g}} = 1 \ \Omega \end{array}$	P-Ch 1	-	43	-	
		$\label{eq:VDD} \begin{array}{l} V_{DD} = 100 \text{ V}, \text{R}_{\text{L}} = 5.2 \ \Omega \\ \text{I}_{\text{D}} = 10 \text{ A}, \text{V}_{\text{GEN}} = 10 \text{ V}, \text{R}_{\text{g}} = 2.5 \ \Omega \end{array}$	N-Ch 3	-	15	-	
		$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 20 \text{ V}, \ R_{\text{L}} = 2 \ \Omega \\ I_{\text{D}} = 10 \ A, \ V_{\text{GEN}} = 10 \ V, \ R_{\text{g}} = 1 \ \Omega \end{array}$	N-Ch 2	-	10	-	
Fall time	t _f	$\label{eq:VDD} \begin{array}{l} V_{DD} = \text{-20 V, } R_L = 2 \ \Omega \\ I_D = \text{-10 A, } V_GEN = \text{-10 V, } R_g = 1 \ \Omega \end{array}$	P-Ch 1	-	19	-	
		$\label{eq:VDD} \begin{array}{l} V_{DD} = 100 \text{ V}, \text{R}_{\text{L}} = 5.2 \ \Omega \\ \text{I}_{\text{D}} = 10 \text{ A}, \text{V}_{\text{GEN}} = 10 \text{ V}, \text{R}_{\text{g}} = 2.5 \ \Omega \end{array}$	N-Ch 3	-	2	-	
Source-Drain Diode Ratings	s and Characteristics	•					
Pulsed current			N-Ch 2	-	-	120	
	I _{SM}		P-Ch 1	-	-	-120	Α
			N-Ch 3	-	-	50	
Forward voltage		$I_{S} = 6.5 \text{ A}, V_{GS} = 0 \text{ V}$	N-Ch 2	-	0.79	-	
	V _{SD}	$I_{\rm S}$ = -3.4 A, $V_{\rm GS}$ = 0 V	P-Ch 1	-	-0.78	-	V
		I _S = 19 A, V _{GS} = 0 V	N-Ch 3	-	0.9	-	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

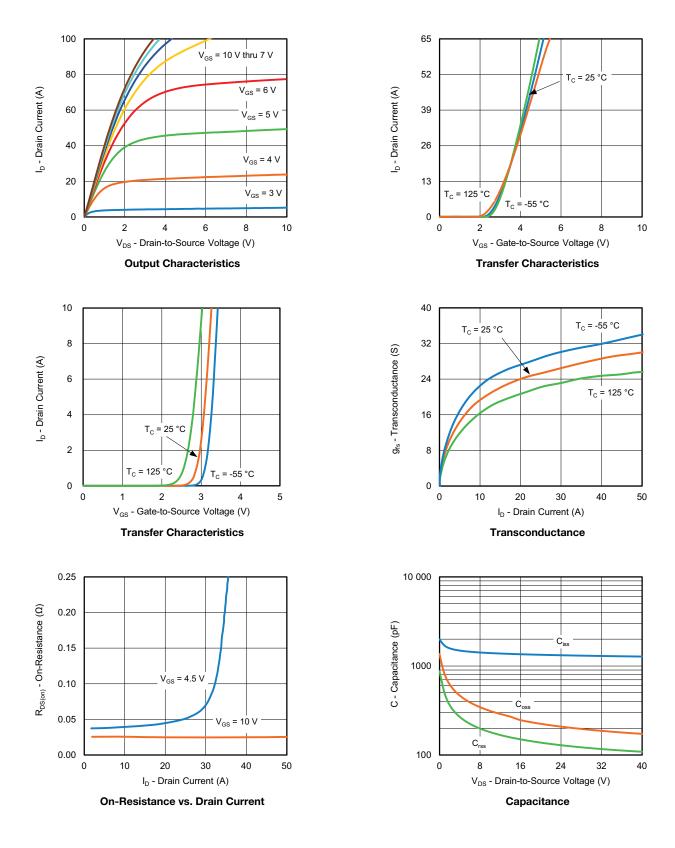
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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CHANNEL-1 TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



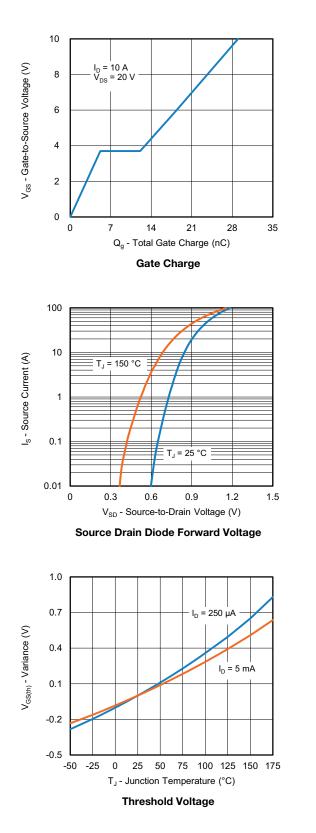
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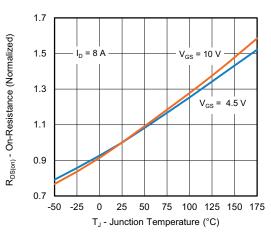
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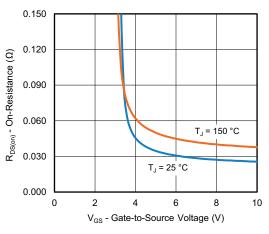


CHANNEL-1 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

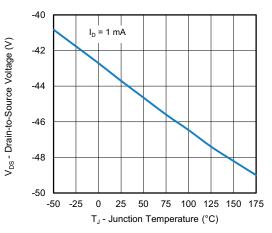




On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature

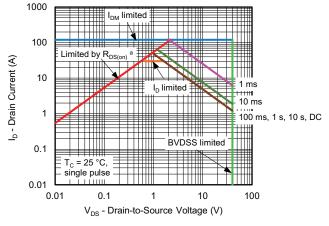
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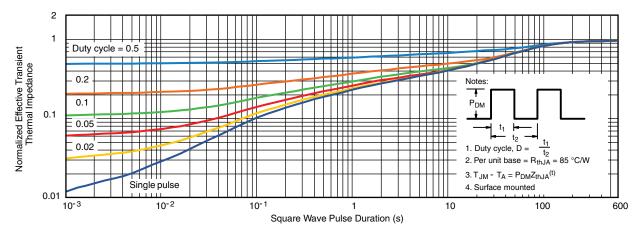
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CHANNEL-1 TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Safe Operating Area



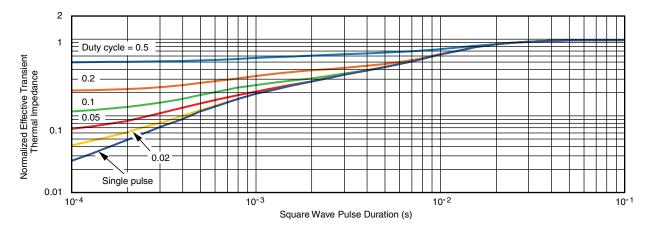
Normalized Thermal Transient Impedance, Junction-to-Ambient

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



CHANNEL-1 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

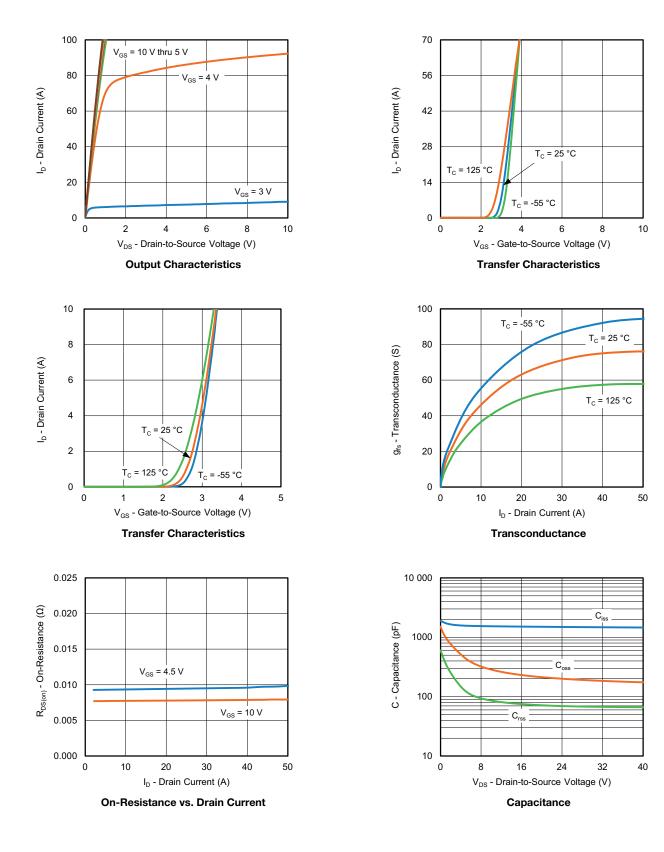
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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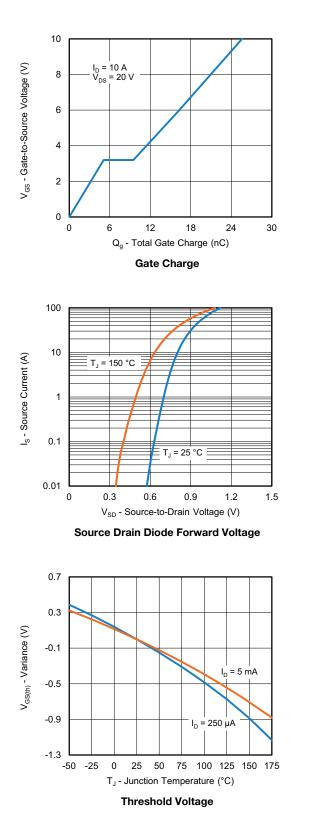
CHANNEL-2 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

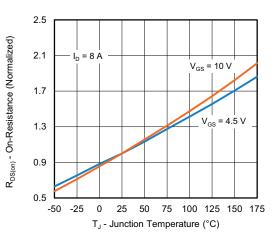


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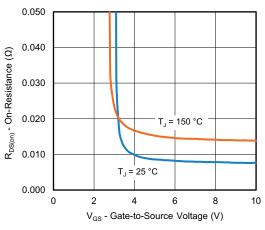


CHANNEL-2 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

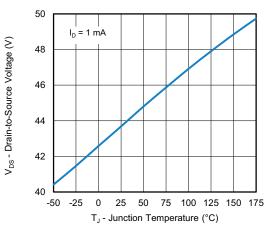




On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature

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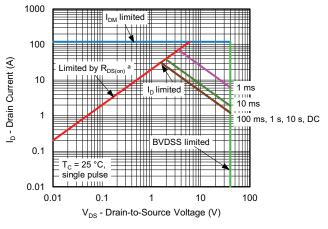
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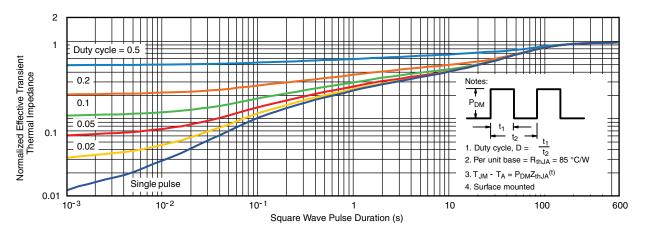
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CHANNEL-2 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

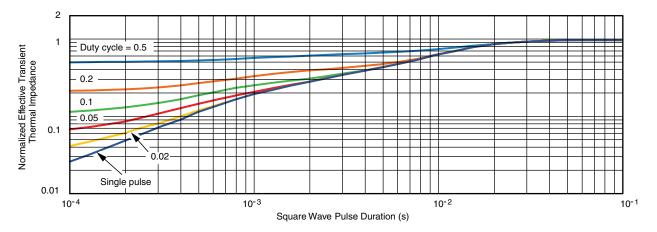
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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CHANNEL-2 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

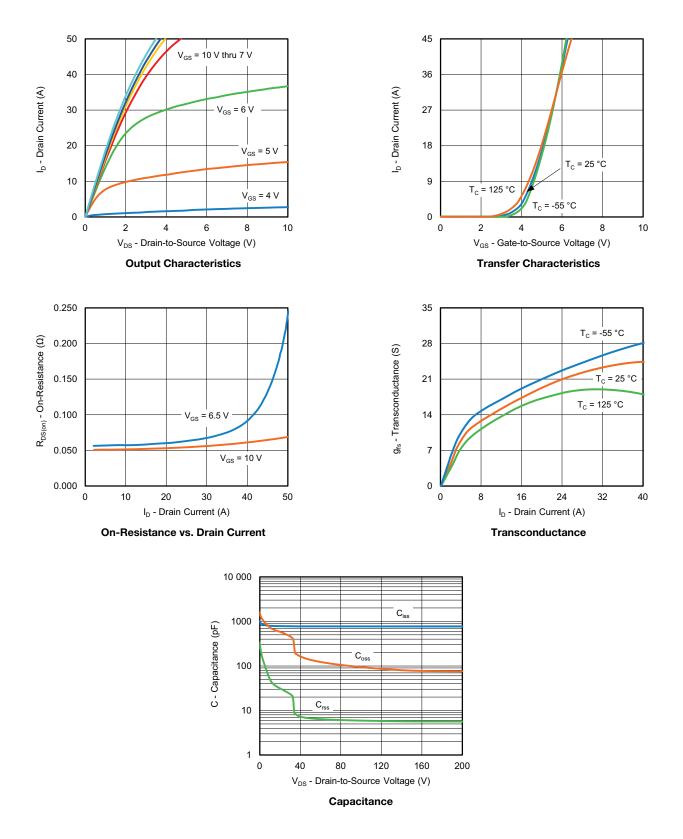
Note

- The characteristics shown in the two graphs
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions



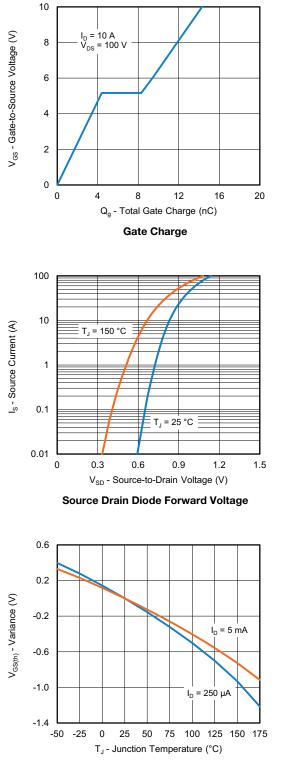
CHANNEL-3 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



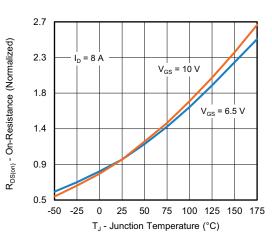
12



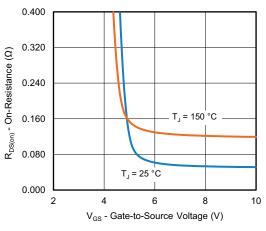
CHANNEL-3 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



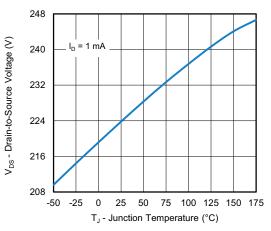
Threshold Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature

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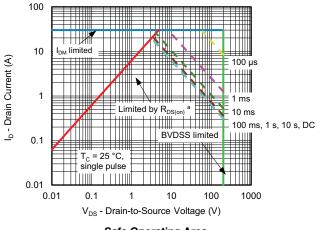
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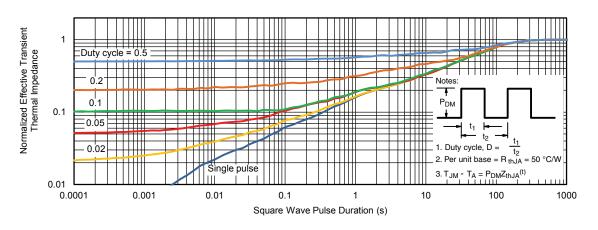
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CHANNEL-3 TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Safe Operating Area



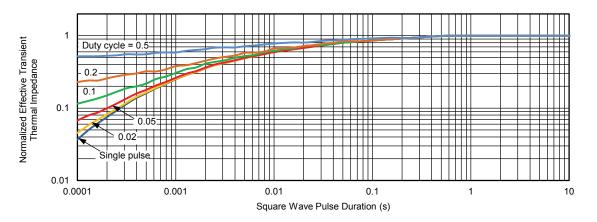
Normalized Thermal Transient Impedance, Junction-to-Ambient

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



CHANNEL-3 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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